

A4

KH-IPEx-K501-29

RECOMMENDED PCB LAYOUT (TOLERANCE: ±0.05)

- ▨ CENTER CONTACT
- ▩ GROUND CONTACT

RECOMMENDED PCB LAYOUT (TOLERANCE: ±0.05)

NOTE:

1. HOUSING MATERIAL: THERMOPLASTIC, white, UL 94V-0;
CONTACT MATERIAL: COPPER ALLOY;
GOLD PLATED: CONTACT AREA 2u" Min & SOLDER AREA 1u" Min;
SHELL MATERIAL: COPPER ALLOY;
GOLD PLATED: CONTACT AREA 0.0508um Min & SOLDER AREA 0.0254um Min;
2. PERFORMANCE:
 - 2.1. CONTACT RESISTANCE: 20mOHM Max.
 - 2.2. DIELECTRIC WITHSTANDING VOLTAGE: 100V AC FOR 1MINUTE;
 - 2.3. INSULATION RESISTANCE: 500MOHM Min.
3. COMPLIABILITY: 0.1mm Max.
4. APPLIED TO IR SOLDERING PROCESS.

REV	ECON NO	DESCRIPTION	DATE	APPD
A		NEW RELEASE	2016.12.09	曾庆勇

EXTEND USE		TITLE	
RF1 BOARD CONN		RF1 BOARD CONN ASSEMBLY DWG	
GENERAL TOLERANCE		DWG NO 19.0022A0	
DIMENTION	ANGLES	QTY	P/N
0, ±0.10	0, ±3.0°		19.0022A0-0001R0
.0 ±0.05	.0 ±2.0°	FINISHED	SHEET 1/1
.00 ±0.03	.00 ±1.0°	DRN 丁济松	SCALE 1:1
.000 ±0.02			REV A